Type JAG

Type JAG micro fuse is designed for circuit protection against excessive current in portable electronic equipment, electric circuit around battery, etc. because the demand for high capacity batteries is increasing.

Wire material is adopted for fuse element, and the performance against rush current is increased in spite of compact design. Also, the ecology design of Type JAG is environmentally friendly because of complete lead-free.

FEATURES

- 1. Our original construction design has excellent fusing and cutting characteristics.
- 2. Especially, performance against rush current is excellent since wire material is used for fuse element.
- 3. Surface temperature rise is 75°C or less when applying rated current for fusing. This gives less influence to the peripheral units.
- 4. Resistance to soldering heat: Reflow or flow soldering 10 seconds at 260 °C
- 5. Our original terminal construction makes almost no occurrence of Tombstone phenomenon.
- 6. Small size of 3216 (3.2 \times 1.6 \times 1.6 mm)
- 7. Suitable for automatic mounting
- 8. Precise dimensions allows high-density mounting and symmetrical construction of terminals provide "Self-Alignment".
- 9. Complete lead-free

RATING

| Item | Rating |
|---|---|
| Category Temperature Range | - 40 ~ +125℃ |
| Rated Current | 0.5-0.63-0.8-1.0-1.25-1.6-2.0-2.5-3.15-4.0A |
| Rated Voltage | 32VDC |
| Voltage Drop | Refer to CATALOG NUMBERS AND RATING |
| Insulation Resistance (between terminals and case) | 1000 MΩ or more |
| Fusing Characteristics | Fusing within 1 minute if the current is 200% of rated current. |
| Clearing Characteristics | Breaking voltage : 32 V |
| | Breaking current : 50 A |

ORDERING INFORMATION

| Туре | Code | RV | Code | Rated current | Code | Rated current | Code | Package type | Code | Case size |
|------|------|-----|------|---------------|------|---------------|------|--------------|------|-----------|
| JAG | 3202 | 32V | 501 | 0.5 A | 162 | 1.6 A | NA | φ180 Reel | 52 | 3.2×1.6 |
| | | | 631 | 0.63A | 202 | 2.0 A | | | | |
| | | | 801 | 0.8 A | 252 | 2.5 A | | | | |
| | | | 102 | 1.0 A | 322 | 3.15A | | | | |
| | | | 132 | 1.25 A | 402 | 4.0 A | | | | |

CATALOG NUMBERS AND RATING

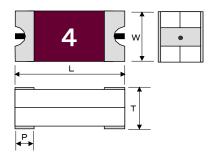
November, 2010

| Catalog number | Case size | Rated current A | Internal resistance mΩ (Typical) | Voltage drop mV (Max.) | Rated voltage VDC | Breaking current A |
|---------------------|-----------|--------------------|--|------------------------------|----------------------|-----------------------|
| JAG 3202 501 □□52 | 3.2×1.6 | 0.5 | 310 | 280 | | |
| JAG 3202 631 □□52 | 3.2×1.6 | 0.63 | 240 | 240 | | |
| JAG 3202 801 □□52 | 3.2×1.6 | 0.8 | 190 | 200 | | |
| JAG 3202 102 □ □ 52 | 3.2×1.6 | 1.0 | 145 | 200 | | |
| JAG 3202 132 □□52 | 3.2×1.6 | 1.25 | 118 | 200 | 32 | 50 |
| JAG 3202 162 □□52 | 3.2×1.6 | 1.6 | 93 | 200 | 52 | 50 |
| JAG 3202 202 □□52 | 3.2×1.6 | 2.0 | 70 | 200 | | |
| JAG 3202 252 □□52 | 3.2×1.6 | 2.5 | 54 | 200 | | |
| JAG 3202 322 □□52 | 3.2×1.6 | 3.15 | 43 | 200 | | |
| JAG 3202 402 □□52 | 3.2×1.6 | 4.0 | 34 | 200 | | |

For the taping type, the packing code "NA" will be entered in $\Box \Box$.

Catalog numbers are approved by UL and cUL. (File No.E170721)

DIMENSIONS



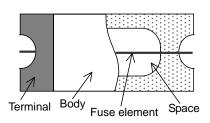
Main body : Glass epoxy

| Terminal : Tin plating (mm) | | | | | | |
|-----------------------------|-----------|---------------------|----------------------|----------------------|---------------------|--|
| Case size | Case code | L | W | Т | Р | |
| 3216 | 52 | 3.2 ^{±0.2} | 1.6 ^{± 0.2} | 1.4 ^{± 0.2} | 0.6 ^{±0.2} | |

MARKING

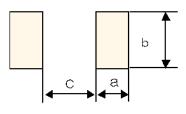
| Code | : | Rated current | Code | : | Rated current |
|------|---|---------------|------|---|---------------|
| Т | : | 0.50A | Х | : | 1.60A |
| U | : | 0.63A | 2 | : | 2.00A |
| V | : | 0.80A | Y | : | 2.50A |
| 1 | : | 1.00A | 3 | : | 3.15A |
| W | : | 1.25A | 4 | : | 4.00A |

CONSTRUCTION

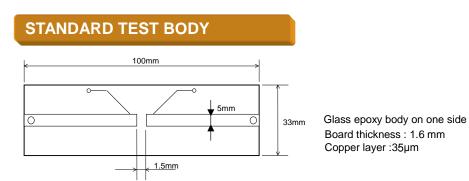


| Name | Material, standard, and treatment |
|--------------|-----------------------------------|
| Fuse element | Lead-free alloy |
| Space | — |
| Terminal | Tin plating |
| Body | Glass epoxy |

RECOMMENDED PAD DIMENSIONS



| | (mm) | | | |
|----------|-----------|--|--|--|
| | Size 3216 | | | |
| а | 1.0 | | | |
| b | 1.6 | | | |
| С | 1.6 | | | |
| (Reflow) | | | | |

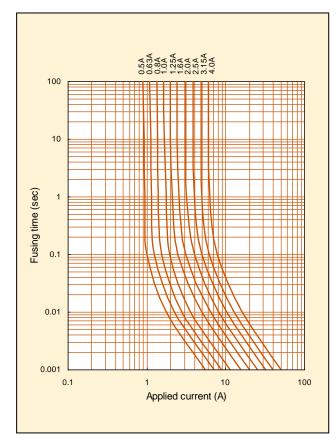


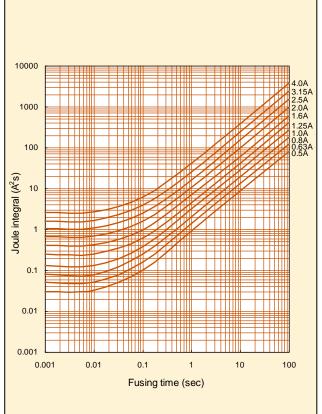
PERFORMANCE

| No. | Item | Performance | Test method |
|-----|--|---|--|
| 1 | Temperature rise | Temperature rise shall not exceed 75°C. | Apply rated current. |
| 2 | Current-carrying capacity | Shall not open within 1 hour. | Apply 100% of rated current. |
| 3 | Clearing characteristics | Arc shall not be continued. Marking shall be legible. | Breaking voltage : 32 V Breaking current : 50 A |
| 4 | Voltage drop | Voltage drop is below the value specified in CATALOG NUMBERS AND RATING. | Apply rated current. |
| 5 | Fusing characteristics | Fusing within 1 min. | Apply 200% of rated current. (Ambient temperature : 10 ~ 30°C) |
| 6 | Insulation resistance | 1000 MΩ or more | Insulation resistance between terminals and case |
| 7 | Electrode strength (Bending) | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Board supporting width : 90 mm Bending speed : Approx. 0.5 mm/sec. Duration : 5 sec. Bending : 3 mm |
| 8 | Shear test | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Applied force : 20 N (2.04 kgf) Duration : 10 sec. Tool : R0.5 Direction of the press : side face |
| 9 | Substrate bending test | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Supporting dimension : 1.6 mm Applied force : 20 N (2.04 kgf) Duration : 10 sec. Tool : R0.5 Direction of the press : thickness direction of product |
| 10 | Solderability (Solder Wetting time) | Solder Wetting time : within 3sec. | Solder : Sn–3Ag–0.5Cu Temperature : 245 \pm 3°C meniscograph method |
| 11 | Solderability (new uniform coating of solder) | The dipping surface of the terminals shall be covered more than 95% with new solder. | Solder : JISZ3282 H60A, H60S, H63A Temperature : 230 ± 2°C meniscograph method Solder : Sn-3Ag-0.5Cu Temperature : 245 ± 3°C Dipping : 3 sec. |
| 12 | Resistance to soldering heat | Marking shall be legible. No mechanical damage. Resistance change after the test shall be within \pm 20%. | Solder : JISZ3282 H60A, H60S, H63A Temperature : 230 \pm 2°C Dipping : 3 sec. Dipping : 1 cycle) Preconditioning : 100 ~ 150°C, 30 \pm 5 sec. Temperature : 260 \pm 3°C, 5 $_{-1}^{+1}$ sec. Reflow soldering (2 cycles) Preconditioning : 150~180°C, 90 \pm 30 sec. Peak : 250 $_{-0}^{+0}$ °C Holding : 230°C or higher, 30 \pm 10 sec. Cooling : 3 ~ 6°C/sec or faster Manual soldering Temperature : 350 \pm 10°C Duration : 2 ~ 3 sec Measure after 1 hour left under room temperature and humidity. |
| 13 | Solvent resistance | Marking shall be legible. No mechanical damage. No significant irregularity in the appearance. | Dipping rinse Solvent : Isopropyl alcohol Duration : 90 sec. |
| 14 | Vibration | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Frequency range : 10 ~ 55 ~ 10 Hz/min Vibration amplitude : 1.5 mm Duration : 2 hours in each of XYZ directions (total : 6 hours) |
| 15 | Shock | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Peak value : 490 m/s ² (50G) Duration : 11 m sec. 6 aspects \times 3 times (total : 18 times) |
| 16 | Thermal shock | No mechanical damage. Resistance change after the test shall be within \pm 20%. | $\begin{array}{l} -55 \ \pm \ 3^\circ C: 30 \ \text{min.} \\ \text{Room temperature}: 2 \sim 3 \ \text{min or less} \\ 125 \ \pm \ 2^\circ C: 30 \ \text{min.} \\ \text{Room temperature}: 2 \sim 3 \ \text{min or less} \\ \text{Repeat above step for 10 cycles} \end{array}$ |
| 17 | Moisture resistance | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Temperature : 85 ± 3°C Humidity : 85 ± 5% RH Duration : 1000 hours |
| 18 | Load life | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Temperature : 85 \pm 2°C Applied current : Rated current \times 70% Duration : 1000 hours |
| 19 | Moisture resistance load | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Temperature : 85 \pm 2°C Humidity : 85 \pm 5% RH Applied voltage : rated current \times 70% Duration : 1000 h |
| 20 | Stability | No mechanical damage. Resistance change after the test shall be within \pm 20%. | Temperature : 125 \pm 2°C Duration : 1000 hours |

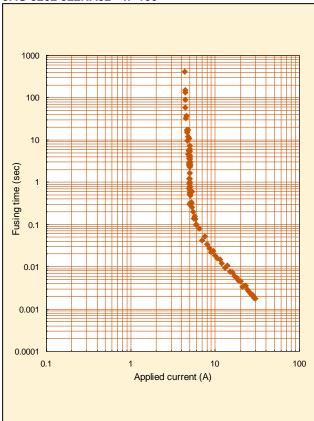
FUSING CHARACTERISTICS

I²T-T CHARACTERISTICS

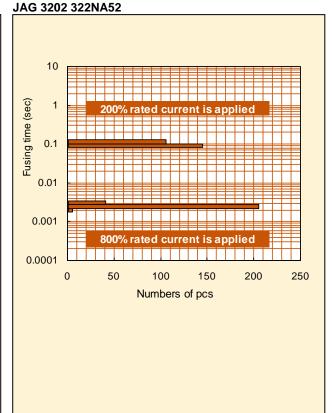




DISTRIBUTION OF FUSING CHARACTERISTICS



DISTRIBUTION OF FUSING TIME



JAG 3202 322NA52 n=100

DETERMINATION OF RATED VALUE AND SELECTION OF MICRO FUSE (TYPE JAG)

Determine the rated value of the micro fuse, and select the correct circuit protection element for your circuit. If you select the correct circuit protection element, safety of your circuit can be ensured. How to determine the rated value of the circuit protection element is described below:

Flow for fuse selection

1. Measurement of circuit values using actual device

Measure the circuit values, such as operating current of the circuit.

2. Calculation from operating current

From the obtained operating current and the category temperature, calculate the <u>minimum rated value</u> to determine the applicable fuse. 3. Calculation from overload current

From the obtained overload current, calculate the maximum rated value to determine the applicable fuse.

4. Calculation from inrush current

From the inrush current, calculate the minimum rated value to determine the applicable fuse.

5. Final determination of rated value

From the calculation results of steps 2 through 4, determine the rated value.

6. Operation check using actual device

After selecting the rating, confirm if the device works properly under the pre-determined conditions.

Fuse selection

1. Measurement of circuit values using actual device

Before determining the rated value of the fuse, preliminarily measure the following using the actual device.

- 1–1 Operating current
- Using an oscilloscope or equivalents, measure the operating current of the circuit.
- 1-2 Overload current

Using an oscilloscope or equivalents, measure the overload current that needs to break the circuit.

1–3 Inrush current

Using an oscilloscope or equivalents, measure the inrush current of the circuit at power-on or power-off. In addition, determine the number of inrush current applied.

1-4 Category temperature

Measure the ambient temperature of the fuse circuit.

EXAMPLE TO SELECT RATINGS OF TYPE JAE

<Fuse selection> Effective operating current : 1.2 A Effective overload current : 6.0 A Inrush current waveform : Fig. A (Pulse width : 1 ms, Wave height : 6.0 A) Numbers to withstand inrush current : 100,000 times Category temperature : 85°C

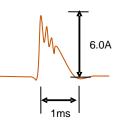


Fig. A : Inrush current waveform

2–1 Measurement of operating current

2. Calculation from operating current

Using an oscilloscope or equivalents, measure operating current (effective current) of the actual circuit. Example : Effective operating current = 1.2 A

2-2 Derating

①Temperature derating factor

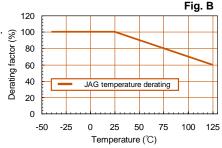
Using Fig. B, find the temperature derating factor correspond to the temperature. ②Rated derating factor

Rated derating factor = 0.78 (Constant irrespective of temperature)

Use Formula 1 to calculate the rated current of the fuse to be used for the circuit. Rated current of fuse \geq Operating current/($(1 \times (2))$... Formula 1

Example : Category temperature = 85°C, Operating current = 1.2 A

(1)Temperature derating factor = 0.76 (Refer to Fig. B.) (2)Rated derating factor = 0.78 (Constant irrespective of temperature) Calculation using Formula 1 : Rated current ≥ $1.2/(0.76 \times 0.78) = 2.02 \text{ A}$



The above calculation result shows that the fuse with rated current of 2.02 A or more should be selected for this circuit. Type JAG, with <u>rated current of 2.5 A or more</u> can be selected.

- 3. Calculation from overload current
- 3-1 Measurement of overload current

Using oscilloscope or equivalents, measure the overload current that needs to break the circuit. Example : Effective overload current = 6.0 A

3-2 Calculation from overload current

Determine the rated current so that the overload current can be 2.0 times larger than the rated current. Use Formula 2 to calculate the rated current of the fuse.

Rated current of fuse ≤ Overload current/2.0 ... Formula 2

Example : Overload current = 6.0 AUse Formula 2 to calculate the rated current. Rated current $\leq 6.0/2.0 = 3.0 \text{ A}$

The above calculation result shows that the fuse with rated current of 3.0 A or less should be selected for this circuit.

Type JAG, with <u>rated current of 2.5 A or less</u> can be selected.

4. Calculation from inrush current

- 4–1 Measurement of inrush current waveform
 Using an oscilloscope or equivalent, measure the waveform of the inrush current of the actual circuit.
- 4-2 Creation of approximate waveform

Generally, the waveform of inrush current is complicated. For this reason, create the approximate waveform of inrush current as shown on Fig. C to simplify calculation.

- 4–3 Calculation of I²t of inrush current
 - Calculate $I^{2}t$ (Joule integral) of the approximate waveform. The formula for this calculation depends on the approximate waveform. Refer to Table A. Example : Pulse applied = 1 ms, Peak value = 6.0 A

Approximate waveform = Triangular wave Since the approximate waveform is a triangular wave, use the following formula for calculation. $I^{2}t$ of rush current = $1/3 \times Im^{2} \times t$... Formula 3 (Im : Peak value, t : Pulse applying time) Use Formula 3 to calculate $I^{2}t$ of the rush current: $I^{2}t = 1/3 \times 6 \times 6 \times 0.001 = 0.012$ (A²s)

JOULE-INTEGRAL VALUES FOR EACH WAVEFORM

6.0A

Fig. C : Inrush current waveform Red line : Actual measurement waveform Black line : Approximate waveform

Table A I²t I²t Name Waveform Name Waveform $I m^2 t_1 + I m^2 (t_2 - t_1) +$ Sine wave Trapezoidal $3 \frac{1}{2} \text{Im}^2(t_3-t_2)$ $\frac{1}{2}$ I m²t (1 cycle) wave Various Sine wave $\frac{1}{2}$ I m²t $I_{1}I_{2}t + \frac{1}{3}(I_{1}-I_{2})^{2}t$ (half cycle) wave 1 $\frac{\frac{1}{3}}{(t_2-t_1)+\frac{1}{3}I_2^2(t_3-t_2)}^{(I_1-I_2)}$ Triangular Various $\frac{1}{3}$ I m²t wave 2 wave Charge/ Rectangular $\frac{1}{2}$ I m²t I m²t discharge Ì. Im wave waveform

*Following formula is generally used for calculation of I²t as i(t) equal to current.

```
I<sup>2</sup>t=\int_0^t i^2(t) dt
```

4-4 Search of load ratio

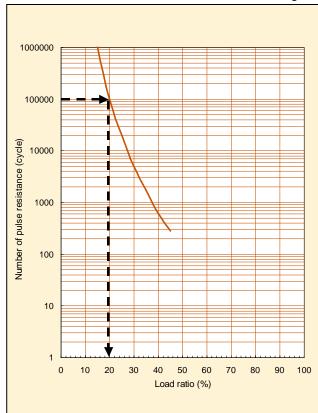
- ①Set up the number of cycles to withstand. (generally 100,000 times)
- ②Obtain the load ratio from Pulse resistance characteristics. (Fig. D)
- Example : 100,000 times is required against inrush current applied.

The load ratio is 20% or less from Fig. D.

PULSE RESISTANCE CHARACTERISTICS

Fig. D

Fig. E



4–5 Calculation from Joule integral and load ratio

Use Formula 4 to calculate the standard $\mathsf{I}^2\mathsf{t}$ for the fuse to be used.

Standard I²t of fuse > (I²t of inrush current/load ratio)Formula 4

Example : I^2 t of pulse = 0.012 A²s, Pulse applied = 1 ms, Required load ratio = 20%

From Formula 4, Standard I²t of fuse > 0.012/0.2 = 0.06 (A²s)

The standard I^2t of the fuse should be 0.06 (A²s) or more.

Since the rush pulse applied is 1 ms, obtain the intersection of 1 ms (horizontal axis) and 0.06 A^2 s (vertical axis) from Fig. E (refer to the arrow shown in Fig.E).

Select a fuse whose curve is above the intersection. Type JAG, with <u>rated current of 0.8 A or more</u> should be selected.

5. Final determination of rated value

Determine the rated current of the micro fuse. The rated current should meet all the calculation results.

Example : 2.5A meets the all requirement.



After selecting the rating, confirm if the device works properly under the pre-determined conditions.

10000 .0A 3.15A 2.5A 2.0A 1000 1 6A .25/ 100).63 Joule integral (A²s) 10 0.1 0.01 0.001 0.001 0.0001 0.01 0.1 10 100 Fusing time (sec)

JOULE INTEGRAL VS. FUSING TIME

Application Notes for Micro Fuse

. Circuit Design

Micro Fuse should be designated only after confirming operating conditions and the Micro Fuse performance characteristics.

When determining the rated current, be sure to observe the following items :

- (1) Micro Fuse should always be operated below the rated current (the value considered in the temperature derating rate) and voltage specifications. According to item 2,2-2 in page 5.
- (2) Micro Fuse should always be operated below the rated voltage.
- (3) Micro Fuse should be selected with correct rated value to be fused at overload current.
- (4) When Micro Fuse are used in inrush current applications, please confirm sufficiently inrush resistance of Micro Fuse.
- (5) Please do not apply the current exceeding the breaking current to Micro Fuse.
- (6) Use Micro Fuse under the condition of category temperature.
- (7) Micro Fuse should not be used in the primary power source.

Micro Fuse should be selected by determining the operating conditions that will occur after final assembly, or estimating potential abnormalities through cycle testing.

2. Assembly and Mounting

- During the entire assembly process, observe Micro Fuse body temperature and the heating time specified in the performance table. In addition, observe the following items :
- Mounting and adjusting with soldering irons are not recommendable since temperature and time control is difficult.

In case of emergency for using soldering irons, be sure to observe the conditions specified in the performance table.

- (2) Micro Fuse body should not have direct contact with a soldering iron.
- (3) Once Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
- (4) During mounting, be careful not to apply any excessive mechanical stresses to the Micro Fuse.

3. Solvents

For cleaning of Micro Fuse, immersion in isopropyl alcohol for 90 seconds (at $20 \sim 30^{\circ}$ C liquid temp.) will not be damaged.

If organic solvents (Pine AlphaTM, Techno CareTM, Clean ThroughTM, etc.) will be applied to the Micro Fuse, be sure to preliminarily check that the solvent will not damage the Micro Fuse.

4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for Micro Fuse. This may cause damage to the Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions.

If Ultrasonic cleaning process must be used, please evaluate the effects sufficiently before use.

5. Caution During Usage

- (1) Micro Fuse with electricity should never be touched. Micro Fuse with electricity may cause burning due to the Micro Fuse high temperature. Also, in case of touching Micro Fuse without electricity, please check the safety temperature of Micro Fuse.
- (2) Protective eyeglasses should always be worn when performing fusing tests. However, there is a fear that Micro Fuse will explode during test. During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

6. Environmental Conditions

- Micro Fuse should not be operated in acid or alkali corrosive atmosphere.
- (2) Micro Fuse should not be vibrated, shocked, or pressed excessively.
- (3) Micro Fuse should not be operated in a flammable or explosive atmosphere.
- (4) After mounting Micro Fuse on a board, covering Fuses with resin may affect to the electric characteristics of the Micro Fuse. Please be sure to evaluate it in advance.

7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

8. Storage

- (1) Micro Fuse should be stored at room temperature (-10°C ~ +40°C) without direct sunlight but not in corrosive atmosphere such as H₂S (hydrogen sulfide) or SO₂(sulfur dioxide). Direct sunlight may cause decolorization and deformation of the exterior and taping. Also, there is a fear that solderability will be remarkably lower in high humidity.
- (2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products are stored for longer term, please contact Matsuo Sales Department for advice.
- (3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.

9. Disposal

When Micro Fuse are disposed of as waste or "scrap", they should be treated as "industrial waste". Micro Fuse contain various kinds of metals and resins.

10. Samples

Micro Fuse received as samples should not be used in any products or devices in the market. Samples are provided for a particular purpose such as configuration, confirmation of electrical characteristics, etc.



MATSUO ELECTRIC CO., LTD.

Please feel free to ask our sales department for more information on the Micro Fuse.

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